

- N. B. : (1) Question No. 1 is compulsory.
 (2) Attempt any four questions from remaining.
 (3) Figures to the right indicate full marks.
 (4) Assume suitable additional data wherever necessary.

1. Give reasons for any five of the following :—

20

- (a) Thermal runaway is of importance in BJT amplifiers but not so in FET amplifiers.
- (b) Bleeder resistance is required when LC filter is used.
- (c) FET is called as a square Law device.
- (d) An ordinary rectifier diode does not work properly at high frequencies.
- (e) Inverse active β is lower than normal active β .
- (f) Common Base amplifier has largest bandwidth.
- (g) Fixed bias circuit for BJT amplifier yields lowest stability of the dc operating point Q.

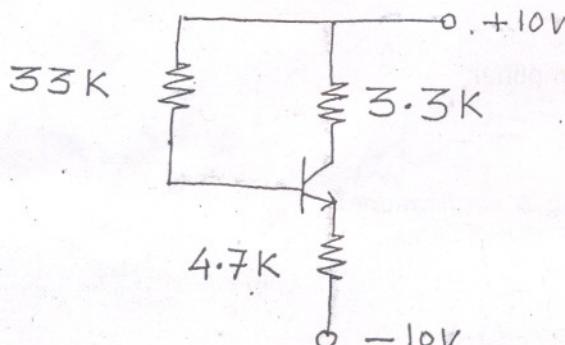
2. (a) How will you use a constant current source for uniform biasing of multiple devices ? Draw a circuit diagram, explain its operation, derive necessary design equations. 10

(b) A Full wave rectifier using center tapped transformer with two diodes gives output DC voltage of 250V to a resistive load, the current being 75 ± 25 mA. If the ripple factor is 0.01, calculate the specifications of the devices and components required if the filter used is L section (LC) filter. 10

3. (a) For the circuit shown in figure,

10

- (i) Find the co-ordinates of operating point Q.
- (ii) Calculate thermal stability factor S_{ICO} & Classify the given biasing circuit.
- (iii) Draw dc Load line & show Q point on it.



Assume,
 $\beta = 100$,
 Si transistor.

(b) Draw circuit diagram of an emitter follower. Derive expressions for current gain A_i , Input resistance R_i , Output resistance R_o and voltage gain A_v . State its important applications. 10

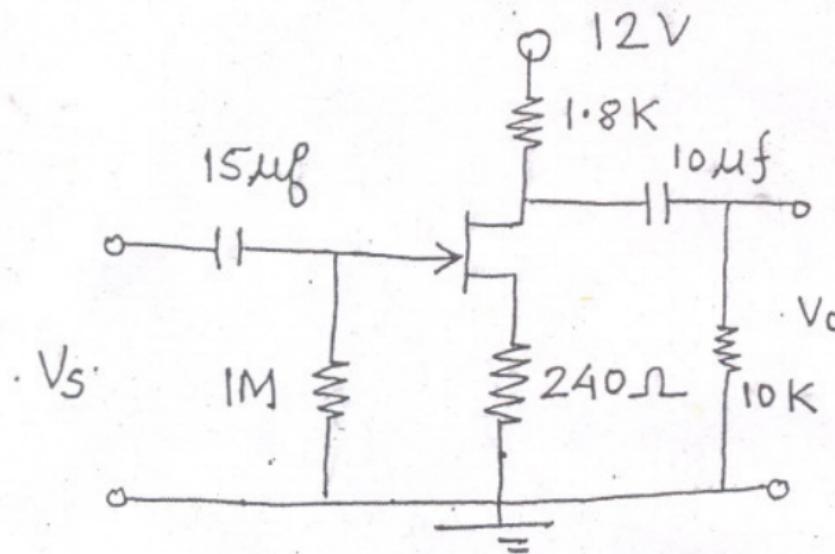
4. (a) Design a single stage RC coupled (Samplifier using FET BFWII biased at mid point to satisfy following specifications. 12

Voltage gain $A_v = 10$,

Lower cut off frequency $F_L = 20\text{Hz}$,

$V_o = 2.5\text{v}$

- (b) For the amplifier shown in figure , find A_v , R_i & R_o . 8



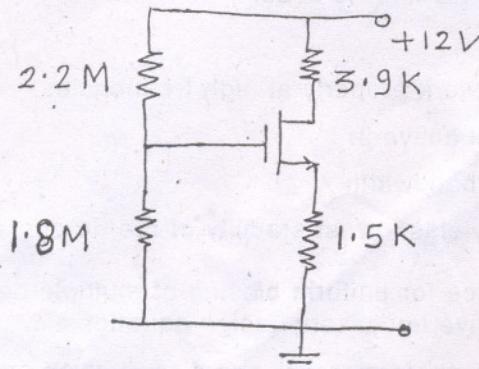
Assume,

$$I_{DSS} = 8\text{mA},$$
$$|V_{GS\text{ off}}| = 3\text{V},$$

$$r_d = 50\text{K}\Omega,$$

$$I_{DQ} = 3.8\text{ mA}$$

5. (a) Draw a circuit diagram of MOSFET amplifier with active load & discuss its analysis. State the advantages of an active load. 10
- (b) Determine the coordinates of operating point Q and State the region of operation of the transistor on output characteristics for the circuit below. 10



Assume,

$$K_n = 0.5 \text{ mA/V}^2,$$

$$V_T = 2 \text{ V}$$

6. Design a single stage RC coupled CE amplifier using transistor with following specifications. The amplifier must have 20

$$|Av| = 180,$$

$$S_{ICO} \leq 8,$$

$$V_o = 3 \text{ V}, V_{cc} = 18 \text{ V}, F_L \leq 20 \text{ Hz}.$$

$$\text{Assume } h_{FE} = hFE = 220, h_{ie} = 2.7 \text{ k}\Omega,$$

$$V_{CE} (\text{sat.}) = 0.25 \text{ V. Neglect } h_{ve} \text{ & } h_{oe}.$$

Calculate A_v , R_i & R_o for the designed amplifier.

7. Write short notes on any four of the following :—

- (a) Base width Modulation.
- (b) Diode clipping circuit — working & applications.
- (c) Avalanche and Zener breakdown mechanisms.
- (d) Solar Cell.
- (e) Condition for zero temperature drift in FET.

ECAD DATA SHEET

Transistor type	P _{dmax} @ 25°C Watts	I _{cmax} @ 25°C Amps	V _{CE} (volts) d.c.	V _{CEO} (volts) d.c.	V _{CEO} (Sus) volts	V _{CER} (Sus) volts	V _{CEx} volts d.c.	V _{BEO} volts d.c.	T _j max °C	D.C. min	current typ.	gain	Small min.	Signal typ.	h _{fe} max.	V _{BE} max.	θ _f °C/IW	Derate above 25°C W/°C
											max.			min.	max.			
2N 3055	115.5	15.0	1.1	100	60	70	90	7	200	20	50	70	15	50	120	1.8	1.5	0.7
ECN 055	50.0	5.0	1.0	60	50	55	60	5	200	25	50	100	25	75	125	1.5	3.5	0.4
ECN 149	30.0	4.0	1.0	50	40	—	—	8	150	30	50	110	33	60	115	1.2	4.0	0.3
ECN 100	5.0	0.7	0.6	70	60	65	—	6	200	50	90	280	50	90	280	0.9	35	0.05
BC147A	0.25	0.1	0.25	50	45	50	—	6	125	115	180	220	125	220	260	0.9	—	—
2N 525(PNP)	0.225	0.5	0.25	85	30	—	—	—	100	35	—	65	—	45	—	—	—	—
BC147B	0.25	0.1	0.25	50	45	50	—	6	125	200	290	450	240	330	500	0.9	—	—

Transistor type	h _{ie}	h _{oe}	h _{re}	θ _{ja}
BC 147A	2.7 KΩ	18 μV	1.5 × 10 ⁻⁴	0.4°C/mw
2N 525 (PNP)	1.4 KΩ	25 μV	3.2 × 10 ⁻⁴	—
BC 147B	4.5 KΩ	30 μV	2 × 10 ⁻⁴	0.4°C/mw
ECN 100	50 Ω	—	—	—
ECN 149	15 Ω	—	—	—
ECN 055	12 Ω	—	—	—
2N 3055	6 Ω	—	—	—

BFW 11—JFET MUTUAL CHARACTERISTICS

-V _{GS} volts	0.0	0.2	0.4	0.6	0.8	1.0	1.2	1.6	2.0	2.4	2.8	3.0	3.5	4.0
I _{DS} max. mA	10	9.0	8.3	7.6	6.8	6.1	5.4	4.2	3.1	2.2	2.0	1.1	0.5	0.0
I _{DS} typ. mA	7.0	6.0	5.4	4.6	4.0	3.3	2.7	1.7	0.8	0.2	0.0	0.0	0.0	0.0
I _{DS} min. mA	4.0	3.0	2.2	1.6	1.0	0.5	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0

N-Channel JFET

Type	V _{DS} max. Volts	V _{OG} max. Volts	V _{GS} max. Volts	P _d max. @25°C mW	T _j max. °C	I _{DSS}	g _m (typical)	-V _F Volts	r _d	Derate above 25°C mW/°C	θ _{ja}
2N3822	50	50	50	300 mW	175°C	2 mA	3000 μV	6	50 KΩ	2 mW/°C	0.59°C/mW
BFW 11 (typical)	30	30	30	300 mW	200°C	7 mA	5600 μV	2.5	50 KΩ	—	0.59°C/mW